

MOSFETs Silicon N-Channel MOS (DTMOSVI)

TK190U60Z1

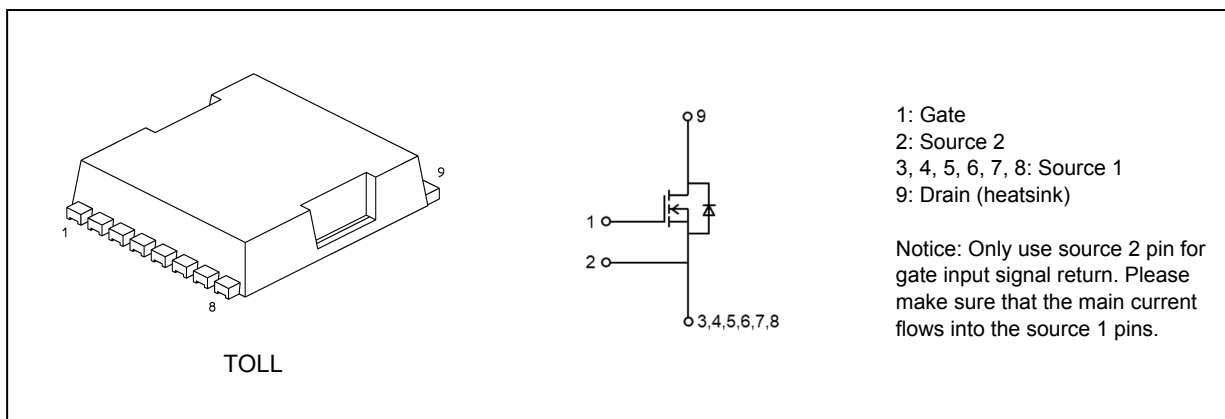
1. Applications

- Switching Power Supplies

2. Features

- (1) Low drain-source on-resistance: $R_{DS(ON)} = 0.158 \Omega$ (typ.)
- (2) High-speed switching properties with the lower capacitance.
- (3) Enhancement mode: $V_{th} = 3$ to 4 V ($V_{DS} = 10$ V, $I_D = 0.48$ mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25 \text{ }^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V_{DSS}	600	V
Gate-source voltage	V_{GSS}	± 30	
Drain current (DC)	I_D	14	A
Drain current (pulsed)	I_{DP}	56	
Power dissipation ($T_c = 25 \text{ }^\circ\text{C}$)	P_D	113	W
Single-pulse avalanche energy	E_{AS}	127	mJ
Single-pulse avalanche current	I_{AS}	3.3	A
Reverse drain current (DC)	I_{DR}	14	
Reverse drain current (pulsed)	I_{DRP}	56	
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production

2025-09

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{th(ch-c)}$	1.1	$^{\circ}C/W$

Note 1: Ensure that the channel temperature does not exceed 150 $^{\circ}C$.

Note 2: $V_{DD} = 90 V$, $T_{ch} = 25^{\circ}C$ (initial), $L = 20.7 mH$, $I_{AS} = 3.3 A$

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	$V_{GS} = \pm 30 V, V_{DS} = 0 V$	—	—	± 1	μA
Drain cut-off current	I_{DSS}	$V_{DS} = 600 V, V_{GS} = 0 V$	—	—	2	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10 mA, V_{GS} = 0 V$	600	—	—	V
Gate threshold voltage	V_{th}	$V_{DS} = 10 V, I_D = 0.48 mA$	3	—	4	
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS} = 10 V, I_D = 4.2 A$	—	0.158	0.190	Ω

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	C_{iss}	$V_{DS} = 300 V, V_{GS} = 0 V, f = 100 kHz$	—	1060	—	μF
Reverse transfer capacitance	C_{rss}		—	1.7	—	
Output capacitance	C_{oss}		—	30	—	
Effective output capacitance (Note 3) (energy related)	$C_{O(er)}$	$V_{DS} = 0 \text{ to } 400 V, V_{GS} = 0 V$	—	50	—	
Effective output capacitance (Note 4) (time related)	$C_{O(tr)}$		—	330	—	
Gate resistance	r_g	$V_{DS} = OPEN, f = 1 MHz$	—	2.8	—	Ω
Switching time (rise time)	t_r	See Figure 6.2.1	—	13	—	ns
Switching time (turn-on time)	t_{on}		—	32	—	
Switching time (fall time)	t_f		—	5	—	
Switching time (turn-off time)	t_{off}		—	55	—	
MOSFET dv/dt ruggedness	dv/dt	$V_{DS} \leq V_{DSS}, I_D \leq 7 A$	70	—	—	V/ns

Note 3: $C_{O(er)}$ is a fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0V to 400V.

Note 4: $C_{O(tr)}$ is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0V to 400V.

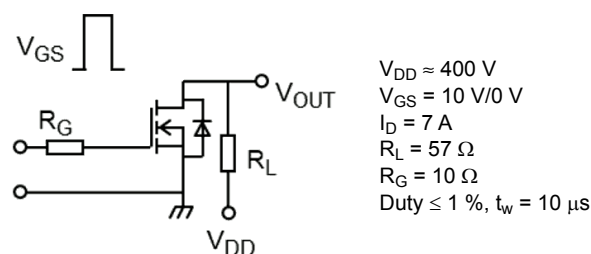


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25\text{ }^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	$V_{DD} \approx 400\text{ V}$, $V_{GS} = 10\text{ V}$, $I_D = 14\text{ A}$	—	20	—	nC
Gate-source charge 1	Q_{gs1}		—	6	—	
Gate-drain charge	Q_{gd}		—	6	—	

6.4. Source-Drain Characteristics ($T_a = 25\text{ }^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Diode forward voltage	V_{DSF}	$I_{DR} = 14\text{ A}$, $V_{GS} = 0\text{ V}$	—	—	-1.7	V	
Reverse recovery time	t_{rr}	$V_{DD} = 400\text{ V}$, $I_{DR} = 7\text{ A}$, $V_{GS} = 0\text{ V}$ $-dI_{DR}/dt = 100\text{ A}/\mu\text{s}$	—	240	—	ns	
Reverse recovery charge	Q_{rr}		—	2.3	—		μC
Peak reverse recovery current	I_{rr}		—	19	—		A
Diode dv/dt ruggedness	dv/dt	$V_{DD} \leq 400\text{ V}$, $I_{DR} \leq 7\text{ A}$, $V_{GS} = 0\text{ V}$	25	—	—	V/ns	

7. Marking (Note)

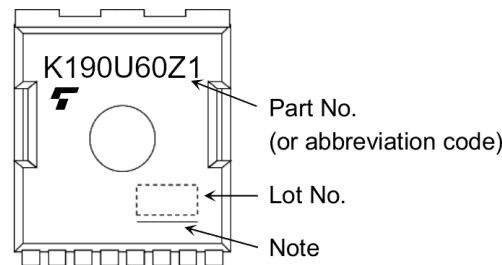


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

8. Characteristics Curves (Note)

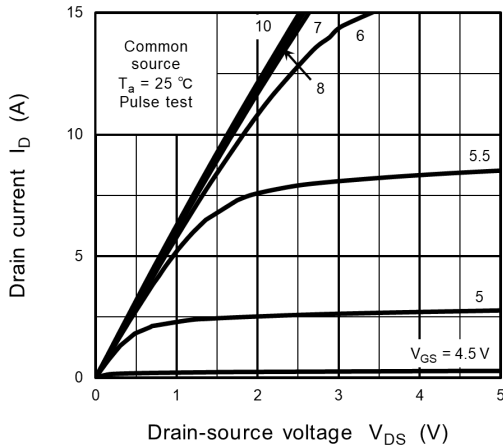


Fig. 8.1 $I_D - V_{DS}$

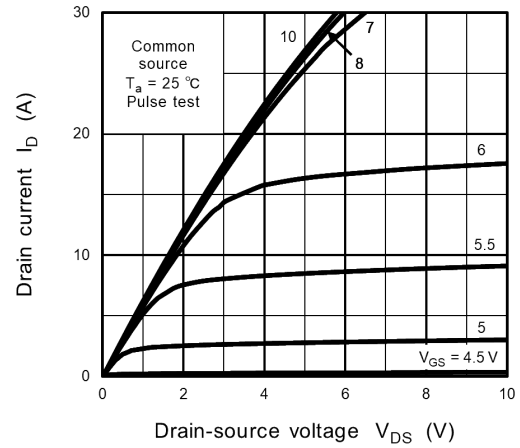


Fig. 8.2 $I_D - V_{DS}$

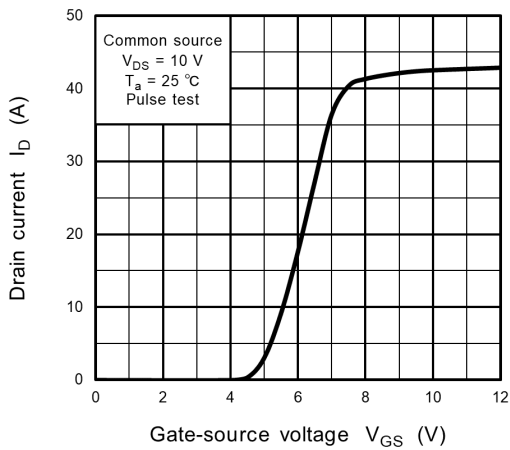


Fig. 8.3 $I_D - V_{GS}$

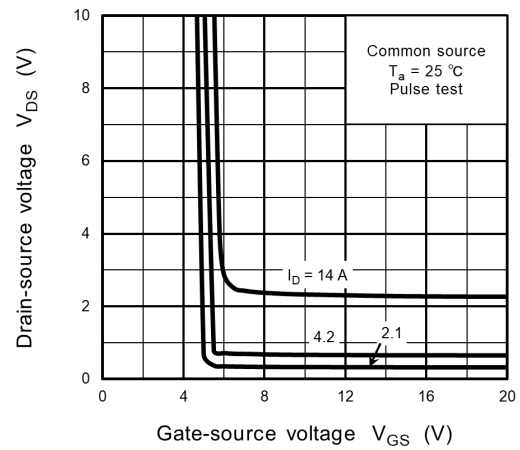


Fig. 8.4 $V_{DS} - V_{GS}$

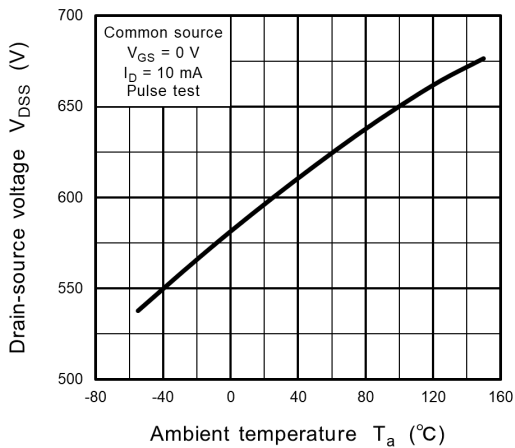


Fig. 8.5 $V_{DSS} - T_a$

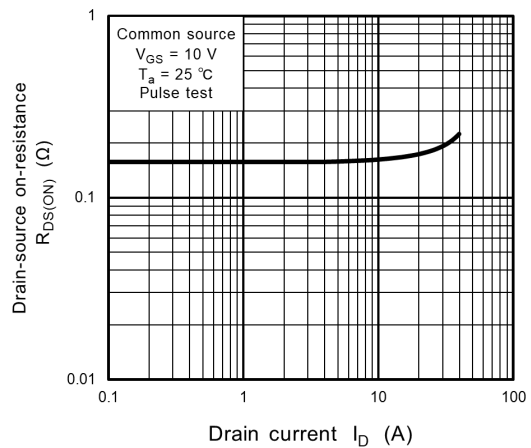


Fig. 8.6 $R_{DS(ON)} - I_D$

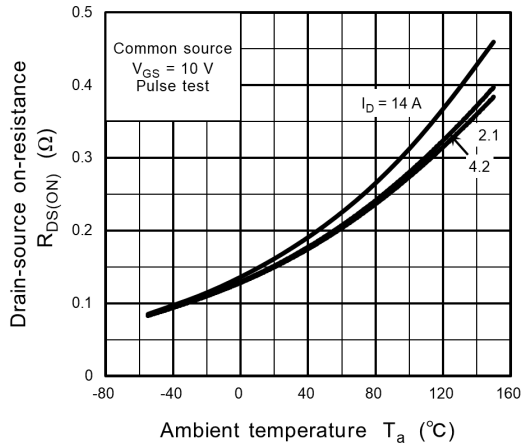


Fig. 8.7 $R_{DS(ON)} - T_a$

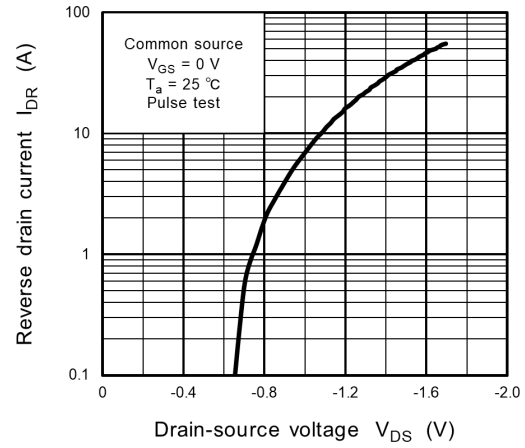


Fig. 8.8 $I_{DR} - V_{DS}$

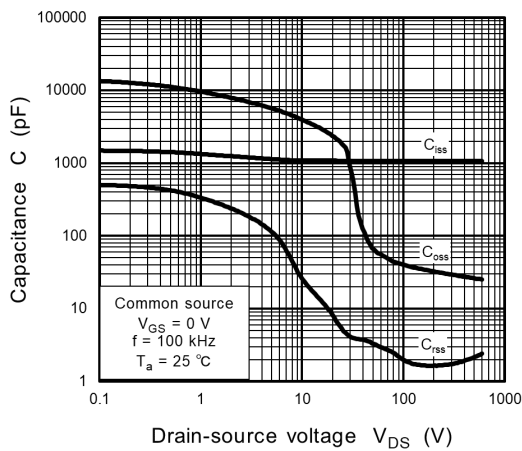


Fig. 8.9 C - V_{DS}

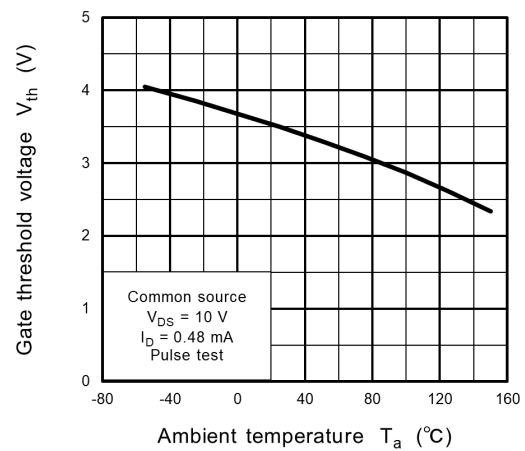


Fig. 8.10 $V_{th} - T_a$

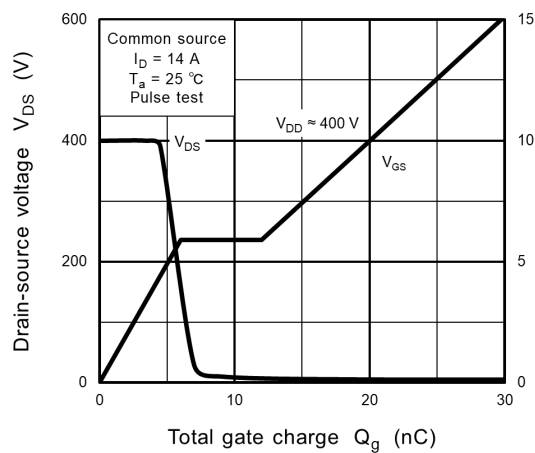


Fig. 8.11 Dynamic Input/Output Characteristics

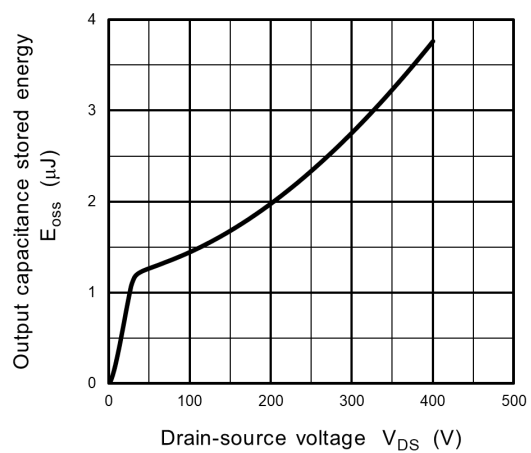


Fig. 8.12 $E_{oss} - V_{DS}$

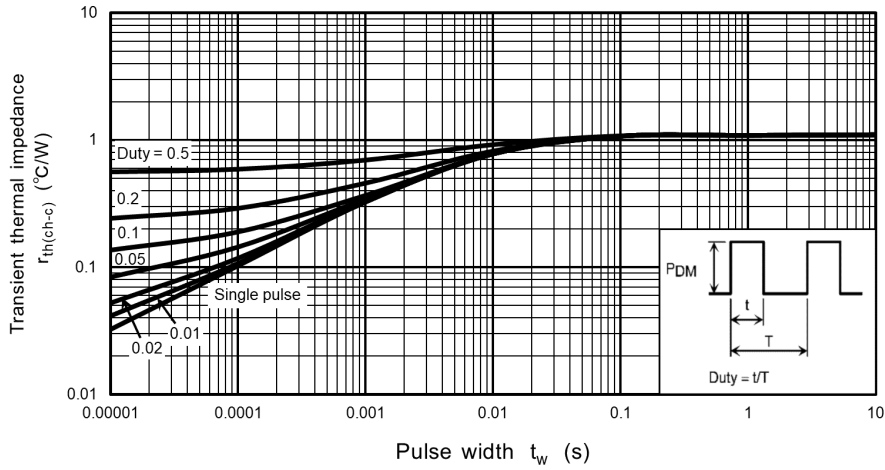


Fig. 8.13 $r_{th} - t_w$
(Guaranteed Maximum)

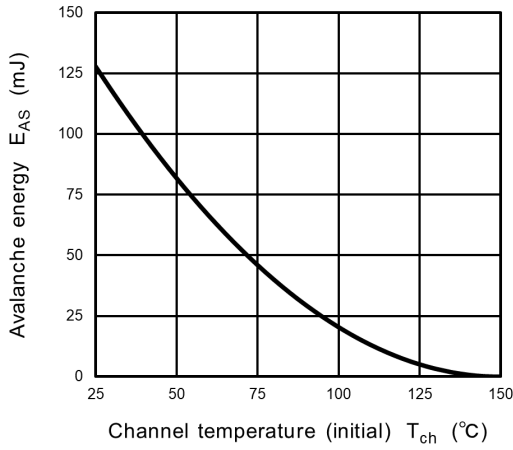


Fig. 8.14 $E_{AS} - T_{ch}$
(Guaranteed Maximum)

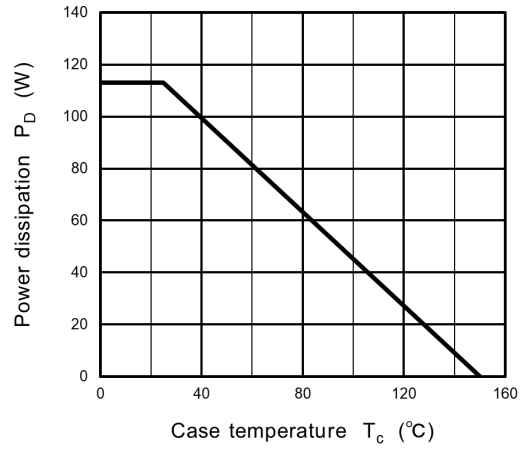
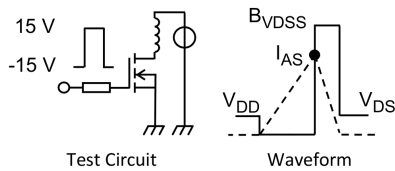


Fig. 8.15 $P_D - T_c$
(Guaranteed Maximum)



$V_{DD} = 90 \text{ V}, L = 20.7 \text{ mH}$ $E_{AS} = \frac{1}{2} \cdot L \cdot I_{AS}^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$

Fig. 8.16 Test Circuit/Waveform

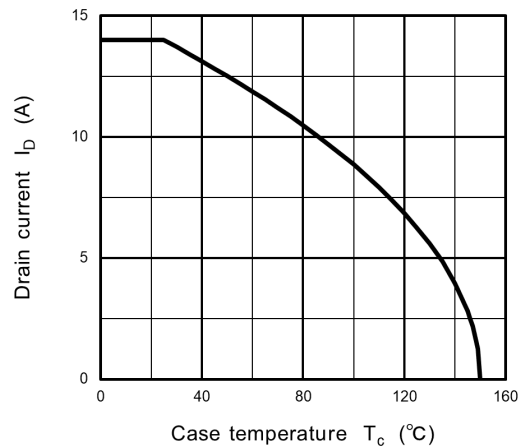


Fig. 8.17 $I_D - T_c$
(Guaranteed Maximum)

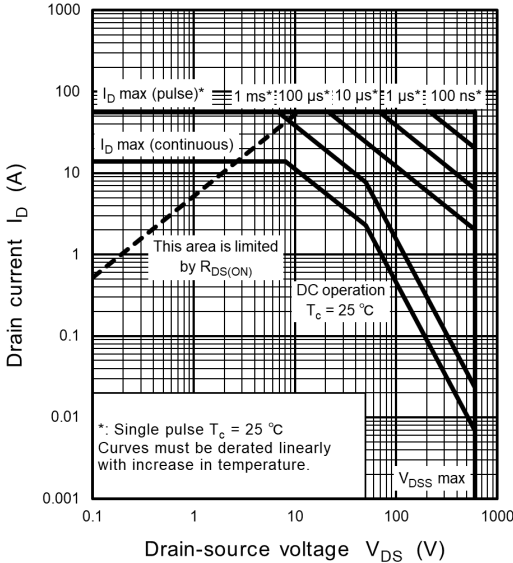
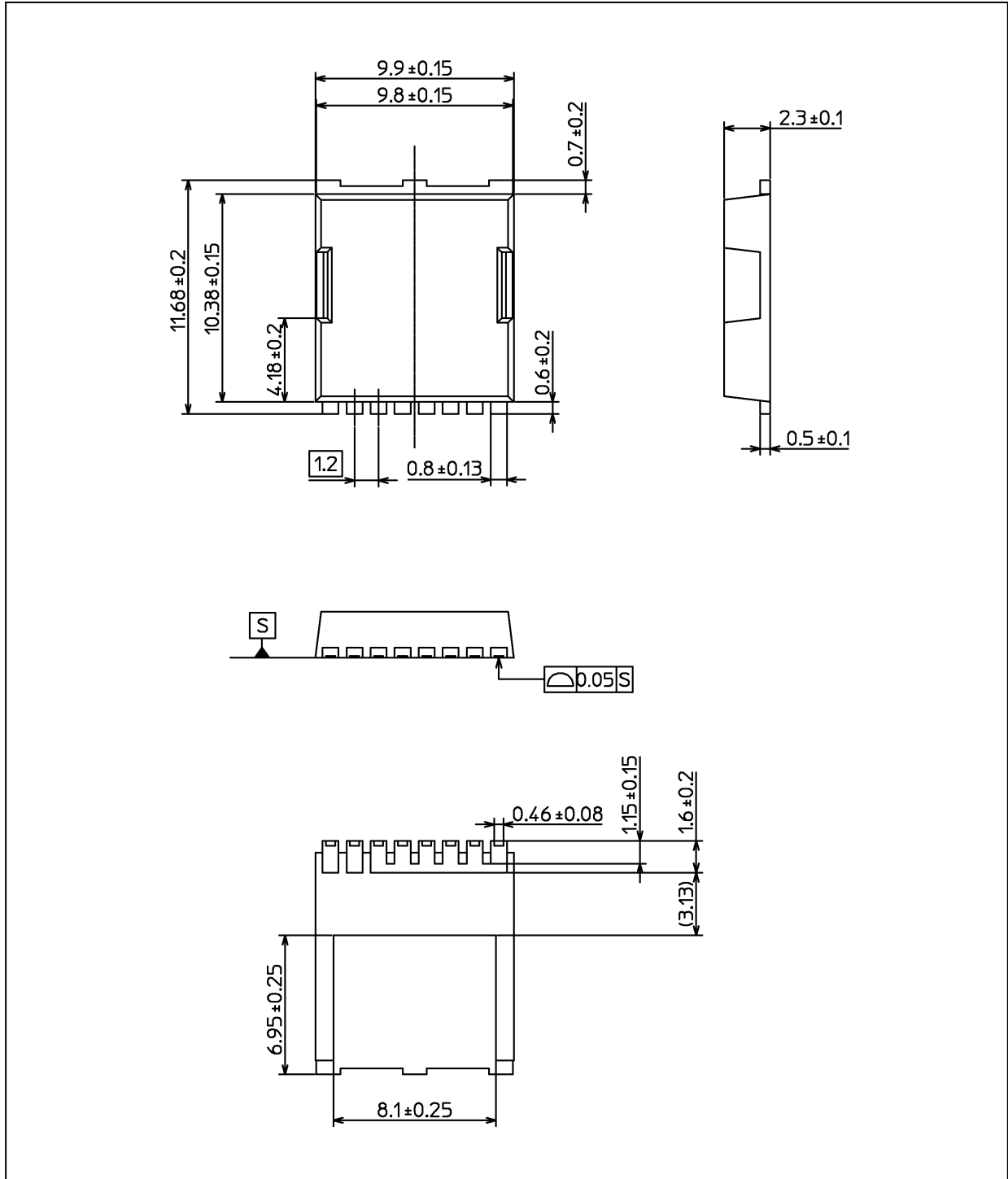


Fig. 8.18 Safe Operating Area (Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 0.75 g (typ.)

Package Name(s)
TOSHIBA: 2-10AF1A
Nickname: TOLL

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